

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Semiconductor devices –
Part 16-5: Microwave integrated circuits – Oscillators**

**Dispositifs à semiconducteurs –
Partie 16-5: Circuits intégrés hyperfréquences – Oscillateurs**



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**Semiconductor devices –
Part 16-5: Microwave integrated circuits – Oscillators**

**Dispositifs à semi-conducteurs –
Partie 16-5: Circuits intégrés hyperfréquences – Oscillateurs**

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SEMICONDUCTOR DEVICES –

**Part 16-5: Microwave integrated circuits –
Oscillators**

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International Standard IEC 60747-16-5 has been prepared by subcommittee 47E: Discrete semiconductor devices, of IEC technical committee 47: Semiconductor devices.

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FDIS	Report on voting
47E/452/FDIS	47E/454/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

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The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

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SEMICONDUCTOR DEVICES –

Part 16-5: Microwave integrated circuits – Oscillators

1 Scope

This part of IEC 60747 specifies the terminology, essential ratings and characteristics, and measuring methods of microwave integrated circuit oscillators.

This standard is applicable to the fixed and voltage-controlled semiconductor microwave oscillator devices, except the oscillator modules such as synthesizers which require external controllers.

NOTE This document is not applicable to the quartz crystal controlled oscillators. They are specified by IEC 60679-1.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60617, *Graphical symbols for diagrams* (available from <<http://std.iec.ch/iec60617>>)

IEC 60747-1:2006, *Semiconductor devices – Part 1: General* ¹⁾
Amendment 1:2010

IEC 60747-4:2007, *Semiconductor devices – Discrete devices – Part 4: Microwave diodes and transistors*

IEC 60747-16-3:2002, *Semiconductor devices – Part 16-3: Microwave integrated circuits – Frequency converters* ²⁾
Amendment 1:2009

IEC 61340-5-1, *Electrostatics – Part 5-1: Protection of electronic devices from electrostatic phenomena – General requirements*

IEC/TR 61340-5-2, *Electrostatics – Part 5-2: Protection of electronic devices from electrostatic phenomena – User guide*

3 Terms and definitions

3.1 oscillation frequency

f_{osc}
frequency measured at the output port

1) A consolidated edition (2010) exists, including IEC 60747-1:2006 and its Amendment 1.

2) A consolidated edition (2010) exists, including IEC 60747-16-3:2002 and its Amendment 1.